### 28 VOLT INPUT – 1.5 WATT

### FEATURES

- Small footprint, 0.79 in<sup>2</sup> (5.1 cm<sup>2</sup>) MCH
- · Surface mount package MGH
- Operating temperature -55°C to +125°C
- 16 to 50 volt input
- Transient protection 80 volts for up to 120 ms
- · 70 volts for 15 volt single and dual models
- Fully isolated, magnetic feedback
- Fixed frequency switching
- Inhibit function
- · Short circuit protection
- Undervoltage lockout
- Up to 79% efficiency, typical



MODELS VDC OUTPUT					
SINGLE	DUAL				
5	±5				
12	±12				
15	±15				

### DESCRIPTION

The Interpoint® MCH Series<sup>™</sup> and MGH Series<sup>™</sup> of DC-DC converters offers up to 1.5 watts of power in a low profile package. The MCH/MGH converters are manufactured in our fully certified and qualified MIL-PRF-38534 Class H production facility and are packaged in hermetically sealed steel cases. They are ideal for use in programs requiring high reliability, small size, and high efficiency. The wide input voltage range of 12 to 50 volts accepts the varying voltages of military, aerospace, or space bus power and tightly regulates output voltages to protect downstream components. Transient protection of 80 volts for up to 120 milliseconds exceeds the requirements of MIL-STD-704A for the 5 and 12 volt single models and the 5 and 12 volt dual models. The 15 volt single and dual converters will withstand transients of up to 70 volts for up to 120 milliseconds.

The MCH and MGH converters are offered with standard screening, /ES, or /883 (MIL-PRF-38534 Class H). See Table 12 on page 13 and Table 13 on page 14. Standard microcircuit drawings (SMD) are available. See Table 3 on page 3 and Table 8 on page 5.

### CONVERTER DESIGN

MCH Series and MGH Series of DC-DC converters incorporate a continuous flyback topology with a constant switching frequency of approximately 370 kHz. Current-mode pulse width modulation (PWM) provides output voltage regulation. Output error voltage is magnetically fed back to the input side of the PWM to regulate output voltage. Regulation is also affected by the load; refer to Table 10 on page 7 and Table 11 on page 8.

Dual models regulate the negative output with magnetic coupling to the positive output. Up to 80% of the total load may be on one output providing that the other output carries a minimum of 20% of the total load. The dual models can be used at double the output voltage by connecting the load between positive and negative outputs, leaving the common unconnected. (ex: MCH2805D can be used as a 10 volt output.)

### INHIBIT FUNCTION

MCH and MGH converters provide an inhibit terminal that can be used to disable internal switching, resulting in no output voltage and an input current as low as 2.3 mA. The converter is inhibited when the inhibit pin is pulled below 0.8 V and enabled when its inhibit pin is left floating. An external inhibit interface should be capable of pulling the converter's inhibit pin below 0.8 V while sinking the maximum inhibit current and also allowing the inhibit pin to float high to enable the converter. A voltage should not be applied to the inhibit pin. The open circuit voltage present on the inhibit pin is 7 to 12 volts.

### **PROTECTION FEATURES**

Undervoltage lockout prevents the converters from operating below approximately 8 volts input voltage to keep system current levels smooth, especially during initialization or re-start operations. All models include a soft-start function to prevent large current draw and minimize overshoot. The converters also provide short circuit protection by restricting the current.

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### MIL-STD-461

Use the Interpoint FMSA-461 (down-leaded) or FMGA-461 (surface mount, side-leaded) EMI filters to pass the CE03 requirements of MIL-STD-461C.

### PACKAGING

#### MCH - Down-leaded package

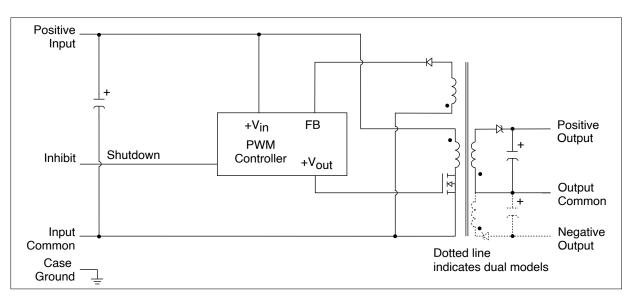
The MCH Series converters are packaged in hermetically sealed, projection-welded steel cases which provide EMI/RFI shielding. See Figure 20 on page 11.

#### MGH - Surface mount package

The surface mount MGH DC-DC converters can be mounted with pick-and-place equipment or manually. It is recommended that the case be attached with flexible epoxy adhesive or silicone which is thermally conductive (>1 watt /meter/°K).

Internal components are soldered with SN96 (melting temperature 221°C) to prevent damage during reflow. Maximum reflow temperature for surface mounting the MGH converter is 220°C for a maximum of 30 seconds. SN60, 62, or 63 are the recommended types of solder. Hand soldering should not exceed 300°C for 10 seconds per pin.

The hermetically sealed metal cases are available in two different lead configurations. See Figure 21 on page 12 and Figure 22 on page 12.



### FIGURE 1: MCH/MGH BLOCK DIAGRAM

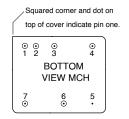
### 28 VOLT INPUT - 1.5 WATT

PIN OUT MCH MODELS					
Pin	Single Output	Dual Output			
1	Positive Input	Positive Input			
2	Input Common	Input Common			
3	Positive Output	Positive Output			
4	Output Common	Output Common			
5	Case Ground	Case Ground			
6	No Connection	Negative Output			
7	Inhibit	Inhibit			

TABLE 1: MCH PIN OUT

MCH PINS NOT IN USE			
Inhibit	Leave unconnected		
"No Connection" pin	Leave unconnected		

TABLE 2: MCH PINS NOT IN USE



See Figure 20 on page 11 for dimensions.

FIGURE 2: MCH PIN OUT

STANDARD MICROCIRCUIT DRAWING (SMD)	MCH SIMILAR PART				
5962-9569601HXC	MCH2805S/883				
5962-9569701HXC	MCH2812S/883				
5962-9569801HXC	MCH2815S/883				
5962-9570201HXC	MCH2805D/883				
5962-9570301HXC	MCH2812D/883				
5962-9570401HXC	MCH2815D/883				
For exact specifications for an SMD product, refer					

to the SMD drawing. SMDs can be downloaded from: https://landandmaritimeapps.dla.mil/ programs/smcr

#### TABLE 3: MCH SMD NUMBER CROSS REFERENCE

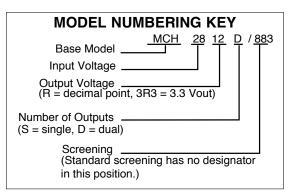


FIGURE 3: MCH MODEL NUMBERING KEY

Screening <sup>3</sup>
(standard, leave blank)
ES
883
/

Notes:

1. Number of Outputs: S is a single output and D is a dual output

2. Case Options: For the standard MCH down-leaded case leave the case option blank. For the MGH straight-lead case, leave the case option blank. For the MGH, surface mount gull-wing case, insert the letter "Z" in the case option position.

3. Screening: For standard screening leave the screening option blank. For other screening options, insert the desired screening level. For more information see Table 12 on page 13 and Table 13 on page 14.

4. If ordering MCH standard (down-leaded) case or MGH standard (straight-leaded) case by model number add a "-Q" to request solder dipped leads (MCH2805S/883-Q). The MGH case Z is always solder-dipped.

TABLE 4: MCH MODEL NUMBER OPTIONS

PIN OUT MGH MODELS					
Pin	Single Output	Dual Output			
1	Positive Input	Positive Input			
2	No Connection No Connection				
3	Input Common	Input Common			
4, 5	Positive Output	Positive Output			
6, 7	Case Ground Case Ground				
8, 9	Output Common	Output Common			
10, 11	Case Ground	Case Ground			
12	No Connection	No Connection			
13, 14	No Connection	Negative Output			
15, 16, 17	No Connection No Connection				
18	Inhibit	Inhibit			

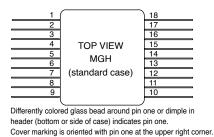
### 28 VOLT INPUT – 1.5 WATT

To meet specified performance for the MGH, all pins must be connected except "No connection" pins and Inhibit pin.

#### TABLE 5: MGH PIN OUT

MGH PINS NOT IN USE				
Inhibit	Leave unconnected			
"No Connection" pins	Connect to case ground for best EMI performance. Also ok to leave unconnected.			

TABLE 6: MGH PINS NOT IN USE



See Figure 21 on page 12 for dimensions and "gull-wing" option.

FIGURE 4: MGH PIN OUT

### 28 VOLT INPUT – 1.5 WATT

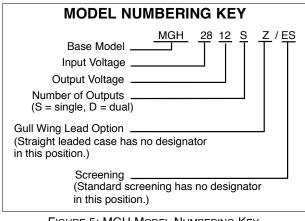


FIGURE 5: MGH MODEL NUMBERING KEY

SMD NUMBERS MGH MODELS	SMD	NUMBERS	MGH MODELS
------------------------	-----	---------	------------

STANDARD MICROCIRCUIT DRAWING (SMD)	MGH SIMILAR PART
5962-9569601HZA	MGH2805SZ/883
5962-9569701HZA	MGH2812SZ/883
5962-9569801HZA	MGH2815SZ/883
5962-9570201HZA	MGH2805DZ/883
5962-9570301HZA	MGH2812DZ/883
5962-9570401HZA	MGH2815DZ/883

For exact specifications for an SMD product, refer to the SMD drawing. SMD numbers are shown for the surface mount gullwing case. For the straight-lead case, replace the Z (HZC) in the SMD with a Y (HYC). SMDs can be downloaded from: https://landandmaritimeapps.dla.mil/programs/smcr

TABLE 7: MGH SMD NUMBER CROSS REFERENCE

<b>MODEL NUMBER OPTIONS</b> To determine the model number enter one option from each category in the form below.						
CATEGORY	Base Model and Input Voltage	Output Voltage	Number of Outputs <sup>1</sup>	Case Options <sup>2</sup>	Screening <sup>3</sup>	
		05, 12, 15	S	MGH – straight leads: leave blank	(standard, leave blank)	
OPTIONS	MGH	05, 12, 15	D	MGH – gull wings: Z (always solder-dipped)	ES	
					883	
FILL IN FOR MODEL # <sup>4</sup>	MGH				/	
Notes:	•				-	

Notes:

1. Number of Outputs: S is a single output and D is a dual output

Case Options: For the MGH straight-lead case, leave the case option blank. For the surface mount gull-wing case, insert the letter "Z" in the case option position.
Screening: For standard screening leave the screening option blank. For other screening options, insert the desired screening level. For more information see Table 12

on page 13 and Table 13 on page 14. 4. If ordering MCH standard (down-leaded) case or MGH standard (straight-leaded) case by model number add a "-Q" to request solder dipped leads

(MCH2805S/883-Q). The MGH case Z is always solder-dipped.

TABLE 8: MGH MODEL NUMBER OPTIONS

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TABLE 9: OPERATING CONDITIONS - ALL MODELS, 25°C CASE, 28 VIN, UNLESS OTHERWISE SPECIFIED.

			ALL MODEL	.S	
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
LEAD SOLDERING TEMPERATURE <sup>1</sup>	10 SECONDS MAX.	_	_	300	°C
SURFACE MOUNT SOLDER REFLOW <sup>1, 2</sup>	SN 60, 62 OR 63 RECOMMENDED	220°C for max. of 30 seconds			conds
STORAGE TEMPERATURE <sup>1</sup>		-65	-	+150	°C
CASE OPERATING	FULL POWER	-55	-	+125	°C
TEMPERATURE	ABSOLUTE <sup>1</sup>	-55	-	+135	Ũ
DERATING OUTPUT POWER/CURRENT <sup>1</sup>	LINEARLY	From	100% at 125	°C to 0%	at 135°C
ISOLATION: INPUT TO OUTPUT, INPUT TO	@ 500 VDC AT 25°C	100	_	_	Megohms
CASE, OUTPUT TO CASE <sup>3</sup>					linegenine
INPUT TO OUTPUT CAPACITANCE <sup>1</sup>		-	100 - 170	_	pF
UNDERVOLTAGE LOCKOUT <sup>1</sup>		—	8	—	V <sub>IN</sub>
CURRENT LIMIT <sup>1, 4</sup>	% OF FULL LOAD	-	125	-	%
AUDIO REJECTION <sup>1</sup>		—	40	—	dB
SWITCHING FREQUENCY	-55° TO +125°C	270	370	470	kHz
INHIBIT ACTIVE LOW (OUTPUT DISABLED)	INHIBIT PIN PULLED LOW	—	-	0.8	VDC
Do not apply a voltage to the inhibit pin. $^{5}$	INHIBIT PIN SOURCE CURRENT <sup>1</sup>	-	-	1	mA
	REFERENCED TO		INPUT C	OMMON	·
INHIBIT ACTIVE HIGH (OUTPUT ENABLED) Do not apply a voltage to the inhibit pin. <sup>5</sup>	INHIBIT PIN CONDITION	OPEN COLLECTOR OR UNCONNECTED		OR	
	OPEN PIN VOLTAGE <sup>1</sup>	7	-	12	V

Notes:

1. Guaranteed by qualification test and/or analysis. Not an in-line test.

2. See Figure 22 on page 12 for more information

3. When testing isolation, input pins are tied together and output pins are tied together. They are tested against each other and against case. Discharge the pins before and after testing.

4. Dual outputs: The over-current limit will trigger when the sum of the currents from both outputs reaches 125% (typical value) of the maximum rated "total" current of both outputs.

5. An external inhibit interface should be used to pull the inhibit low or leave it floating. The inhibit pin can be left unconnected if not used.

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TABLE 10: ELECTRICAL CHARACTERISTICS -55°C TO +125°C CASE, 28 VIN, 100% LOAD, UNLESS OTHERWISE SPECIFIED.

		MCH2805S		MCH2812S		MCH2815S					
MCH/MGH SINGLE OUTPUT MODELS		MGH2805S		MGH2812S			MGH2815S				
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OUTPUT VOLTAGE <sup>2</sup>		4.80	5.00	5.20	11.52	12.00	12.48	14.40	15.00	15.60	VDC
OUTPUT CURRENT	V <sub>IN</sub> = 12 to 50 VDC	0	_	300	0	_	125	0	_	100	mA
OUTPUT POWER	V <sub>IN</sub> = 12 to 50 VDC	0	-	1.5	0	_	1.5	0	—	1.5	W
OUTPUT RIPPLE	$T_{\rm C} = 25^{\circ}{\rm C}$	_	45	150	—	50	200	_	35	150	mV p-p
10 KHZ - 2 MHZ	T <sub>C</sub> = -55°C TO +125°C	—	65	300	-	70	300	—	50	250	
LINE REGULATION	V <sub>IN</sub> = 12 TO 50 VDC	—	40	120	—	70	250	_	80	350	mV
LOAD REGULATION <sup>3</sup>	10% LOAD TO FULL	_	380	800	—	640	1400	_	760	1600	mV
INPUT VOLTAGE	CONTINUOUS	12	28	50	12	28	50	12	28	50	VDC
NO LOAD TO FULL	TRANSIENT <sup>1</sup> 120 msec.	_	_	80	_	_	80	_	_	70	V
INPUT CURRENT	NO LOAD	_	6.0	11	-	6.5	12	_	6.5	12	mA
	INHIBITED	_	2.4	3.5	_	2.4	3.5	_	2.4	3.5	
INPUT RIPPLE CURRENT <sup>4</sup>	10 kHz - 10 MHz	_	130	250	_	150	250	_	150	250	mA p-p
EFFICIENCY	$T_{\rm C} = 25^{\circ}{\rm C}$	72	77	_	74	79	_	74	79	_	%
	T <sub>C</sub> = -55°C TO +125°C	69	75	_	72	77	—	72	77	_	7 /0
LOAD FAULT <sup>5, 6</sup>	POWER DISSIPATION	—	1.4	2.3	—	2.2	3.5	_	2.5	4.0	W
SHORT CIRCUIT	RECOVERY <sup>1</sup>	_	3.5	15	-	3.5	20	_	4.0	20	ms
STEP LOAD RESPONSE 6, 7	TRANSIENT	—	±185	±500	-	±380	±800	_	±380	±800	mV pk
50% - 100% - 50%	RECOVERY	—	125	600	—	130	600	_	180	750	μs
STEP LINE RESPONSE 1, 6, 8,	TRANSIENT	—	180	±500	-	±400	±1000	—	±450	±850	mV pk
12 - 50 - 12 VDC	RECOVERY	—	0.75	4.0	-	0.6	3.0	_	0.5	2.5	ms
START-UP <sup>6</sup>	DELAY	—	10	40	—	10	40	—	10	40	ms
0 - 28 V <sub>IN</sub> , FULL LOAD	OVERSHOOT <sup>1</sup>	_	0	150	_	0	350	_	0	450	mV pk
CAPACITIVE LOAD <sup>1</sup> T <sub>C</sub> = 25°C	NO EFFECT ON DC PERFORMANCE	_	-	200	-	_	200	_	-	200	μF

#### Notes:

1. Guaranteed by qualification test and/or analysis. Not an in-line test.

2. Specified at 50% total Pout.

3. Although no minimum load is required, at no load the output voltage may increase up to 15%.

4. An external 2  $\mu \rm H$  inductor, added in series to the input, is necessary to maintain specifications.

5. Load fault is a short circuit (<50 mohms). Maximum duration of short circuit:  $25^{\circ}C$  – 90 seconds,  $125^{\circ}C$  – 30 seconds. Recovery is into resistive full load.

 Recovery time is measured from application of the transient to point at which Vout is within 1% of final value.

7. Step load test is performed at 10 microseconds typical.

8. Step line test is performed at 100 microseconds  $\pm$  20 microseconds.

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TABLE 11: ELECTRICAL CHARACTERISTICS -55°C TO +125°C CASE, 28 VIN, 100% LOAD, UNLESS OTHERWISE SPECIFIED.

		MCH2805D		MCH2812D		MCH2815D					
MCH/MGH DUAL OUTPUT	MODELS	MGH2805D		MGH2812D			MGH2815D				
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OUTPUT VOLTAGE <sup>2</sup>	±V <sub>OUT</sub>	4.80	5.00	5.20	11.52	12.00	12.48	14.40	15.00	15.60	VDC
OUTPUT CURRENT <sup>3</sup>	EITHER OUTPUT	0	±150	240	0	±62.5	100	0	±50	80	mA
$V_{IN} = 12$ to 50 VDC	TOTAL OUTPUT	_	-	300	_	—	125	—	-	100	
OUTPUT POWER <sup>3</sup>	EITHER OUTPUT	0	±0.75	1.2	0	±0.75	1.2	0	±0.75	1.2	w
$V_{IN} = 12$ to 50 VDC	TOTAL OUTPUT	_	-	1.5	_	—	1.5	_	—	1.5	
OUTPUT RIPPLE	$T_{\rm C} = 25^{\circ}{\rm C}$	-	35	150	—	35	150	—	30	150	mV p-p
10 KHZ - 2 MHZ $\pm$ V <sub>OUT</sub>	T <sub>C</sub> = -55°C TO +125°C	—	50	250	—	40	250	—	35	250	
LINE REGULATION ±V <sub>OUT</sub>	V <sub>IN</sub> = 12 TO 50 V	-	20	100	_	110	400	-	180	650	mV
LOAD REGULATION <sup>4</sup> ±V <sub>OUT</sub>	10% LOAD TO FULL	_	350	700	_	570	1200	_	630	1400	mV
CROSS REGULATION <sup>5</sup>	-V <sub>OUT</sub>	_	-	400	_	_	500	_	_	500	mV
INPUT VOLTAGE NO LOAD TO FULL	CONTINUOUS	12	28	50	12	28	50	12	28	50	VDC
	TRANSIENT <sup>1</sup> 120 msec.	_	_	80	_	_	80	_	_	70	V
INPUT CURRENT	NO LOAD	-	6.0	12	_	8.0	14	_	8.0	14	mA
	INHIBITED	—	2.4	3.5	_	2.4	3.5	_	2.4	3.5	
INPUT RIPPLE CURRENT 6	10 kHz - 10 MHz	—	130	250	_	150	250	_	150	250	mA p-p
EFFICIENCY	$T_{\rm C} = 25^{\circ}{\rm C}$	73	77	_	73	77	_	72	76	_	%
	$T_{C} = -55^{\circ}C TO + 125^{\circ}C$	70	75	_	70	75	—	69	74	—	,-
LOAD FAULT <sup>6, 7</sup>	POWER DISSIPATION	—	1.6	2.5	_	2.7	4.2	_	3.0	4.5	w
SHORT CIRCUIT	RECOVERY <sup>1</sup>	—	3.8	20	_	3.2	20	_	4.0	20	ms
STEP LOAD RESPONSE 7, 8	TRANSIENT	—	±140	±400	—	±260	±700	—	±270	±700	mV pk
50% - 100% - 50%	RECOVERY	—	100	500	—	165	800	—	50	300	μs
STEP LINE RESPONSE 1, 7, 9	TRANSIENT	—	±130	±300	_	±250	±600	_	±230	±600	mV pk
12 - 50 - 12 VDC	RECOVERY	-	0.6	3.0	—	0.9	4.0	—	0.7	4.0	ms
START-UP <sup>7</sup>	DELAY	—	10	45	_	10	45	_	10	45	ms
0 TO 28 V <sub>IN</sub> , FULL LOAD	OVERSHOOT <sup>1</sup>	—	0	150	—	0	350	—	0	900	mV pk
CAPACITIVE LOAD <sup>1</sup> T <sub>C</sub> = 25°C	NO EFFECT ON DC PERFORMANCE	_	-	100	_	_	100	_	-	100	μF

Notes:

1. Guaranteed by qualification test and/or analysis. Not an in-line test.

2. Specified at 50% total  $\mathsf{P}_{\mathsf{OUT}}$  with balanced loads.

3. Up to 80% of the total output current/power is available from either output providing the opposite output carries a minimum of 20% total load.

- 4. Although no minimum load is required, at no load the output voltage may increase up to 15%.
- 5. Cross regulation is specified as the effect on -Vout for the following percentages of total output power: +Po = 20% and -Po = 80% to +Po=80% and -Po=20%

6. Load fault is a short circuit (<50 mohms). Maximum duration of short circuit: 25°C - 90 seconds, 125°C - 30 seconds. Recovery is into resistive full load.

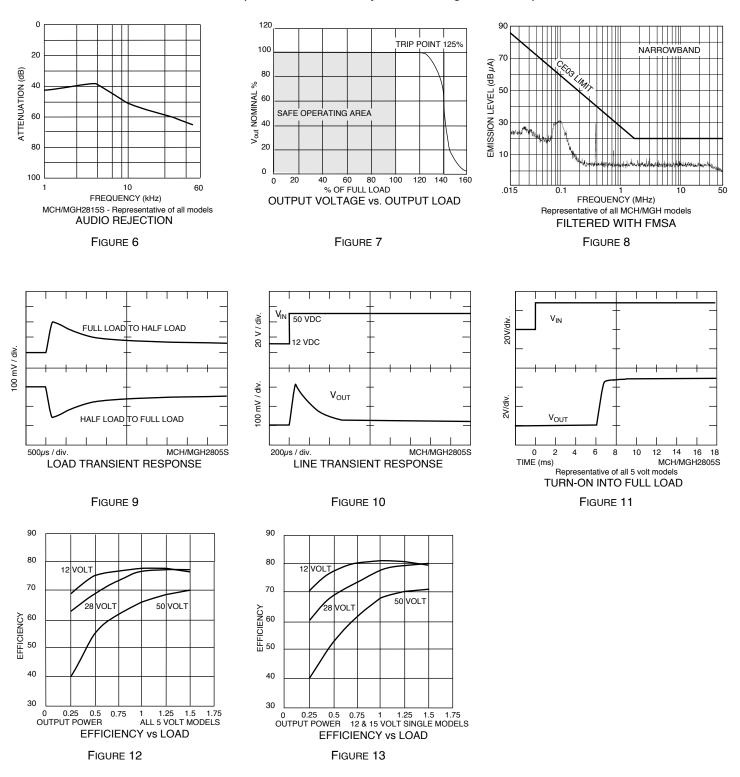
7. Recovery time is measured from application of the transient to point at which Vout is within 1% of final value.

8. Step load test is performed at 10 microseconds typical.

9. Step line test is performed at 100 microseconds  $\pm$  20 microseconds.

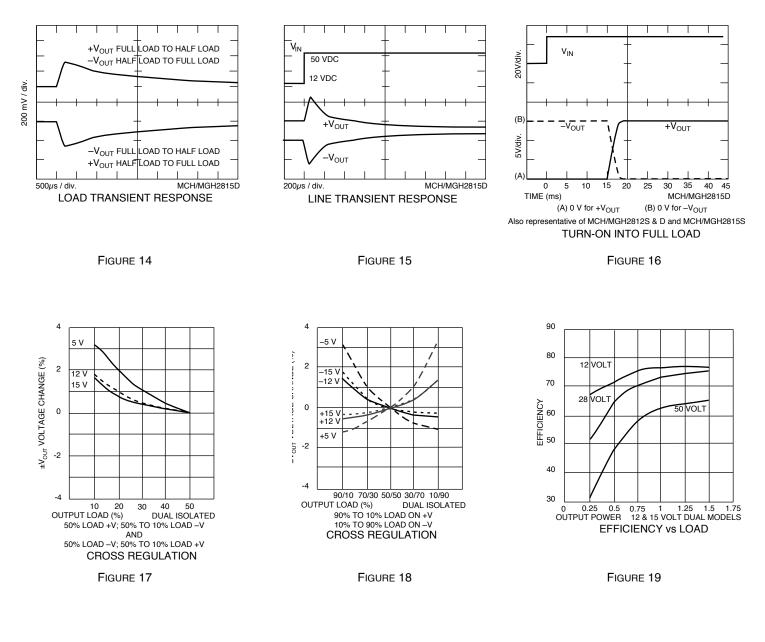
### 28 VOLT INPUT - 1.5 WATT

Typical Performance Plots: 28 Vin, 25°C Case, 100% load, unless otherwise specified. These are examples for reference only and are not guaranteed specifications.



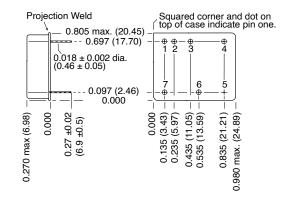
### 28 VOLT INPUT - 1.5 WATT

Typical Performance Plots: 28 Vin, 25°C Case, 100% load, unless otherwise specified. These are examples for reference only and are not guaranteed specifications.



### 28 VOLT INPUT – 1.5 WATT

#### BOTTOM VIEW CASE A2



#### Weight 12 grams typical

Case dimensions in inches (mm) Tolerance ±0.005 (0.13) for three decimal places ±0.01 (0.3) for two decimal places

unless otherwise specified

### CAUTION

Solder pins individually with heat application not exceeding 300°C for 10 seconds per pin.

#### Materials

Header Kovar/Nickel/Gold

Cover Kovar/Nickel Pins Kovar/Nickel/Gold matched glass seal Gold plating of 50 microinches, minimum, included in pin diameter

Seal hole: 0.056 ±0.002 (1.42 ±0.05)

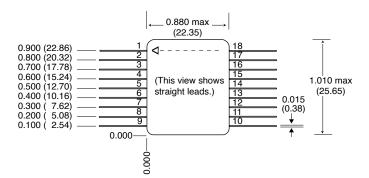
Please refer to the numerical dimensions for accuracy.

FIGURE 20: MCH CASE DIMENSIONS

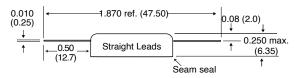
**DOWN-LEADED CASE** 

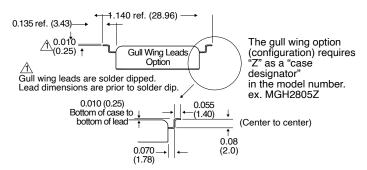
### 28 VOLT INPUT – 1.5 WATT

#### TOP VIEW CASE B



The triangle (ESD) marking on the cover indicates pin one. Cover marking is oriented with pin one at the upper right corner. The straight lead configuration does not require a "case designator" in the model number. ex. MGH2805S





Weight 12 grams maximum

#### Case dimensions in inches (mm)

Tolerance  $\pm 0.005$  (0.13) for three decimal places,  $\pm 0.01$  (0.3) for two decimal places unless otherwise specified. Please refer to the numerical dimensions for accuracy.

#### CAUTION

Maximum reflow temperature is 220°C for a maximum of 30 seconds. SN60, SN62, or SN63 are the recommended types of solder. See MGH gull-wing solder pad layout. Hand soldering should not exceed 300°C for 10 seconds per pin.

#### Materials

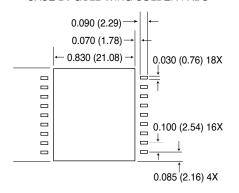
Header Kovar/Nickel/Gold

Cover Kovar/Nickel

Pins Kovar/Nickel/Gold matched glass seal Gold plating of 50 - 150 microinches is included in pin diameter Seal hole: 0.040 ±0.002 (1.02 ±0.05)

Please refer to the numerical dimensions for accuracy.

FIGURE 21: MGH CASE DIMENSIONS



Dimensions in inches (mm)

Tolerance  $\pm 0.005$  (0.13) for three decimal places  $\pm 0.01$  (0.3) for two decimal places, unless otherwise specified. Please refer to the numerical dimensions for accuracy.

#### CAUTION:

Internal components are soldered with SN96 (melting temperature 221°C) to prevent damage during reflow. Maximum reflow temperature for surface mounting the MGH converter is 220°C for a maximum of 30 seconds. SN60, 62, or 63 are the recommended types of solder.

Hand soldering should not exceed 300°C for 10 seconds per pin.

#### SOLDER MASK NOTES

1. Pad dimensions are for the solder mask. Leads common to each other can be connected to each other as desired.

2. Ground (case) pins should be connected to the center pad for improved grounding.

3. Connect "no connection" pins to case ground to reduce EMI.

4. Center pad should not have a solder mask.

5. Adhesive attach is intended to be a surface for soldering the hybrid to the circuit board.

6. Pre-tin base of converter prior to soldering.

7. If less rotation of case is desired, reduce the width of the large case pad by 0.020 inches (0.51 mm). Pad length can be extended 0.010 inches (0.25 mm) towards the case body and an as-desired dimension away from the case body.

8. Do not exceed 220°C as measured on the body of the converter (top or bottom).

9. Attach the body of the case to the board with a thermally conductive adhesive or SN60, 62, or 63 solder. The adhesive can be electrically conductive as well. It can be applied as an underfill post solder or dispensed and cured prior or during solder.

10. In the presence of vibration, to ensure reliable mechanical attachment, the body of the case should be attached with adhesive or solder as noted above (note 7). The leads alone do not provide sufficient mechanical attachment.

Please refer to the numerical dimensions for accuracy.

FIGURE 22: MGH GULL-WING SOLDER PAD LAYOUT

SURFACE MOUNT CASE AND LEAD OPTIONS

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CASE B1 GULL-WING SOLDER PADS

### 28 VOLT INPUT – 1.5 WATT

# ELEMENT EVALUATION <sup>1</sup> HIGH RELIABILITY DC-DC CONVERTERS AND EMI FILTERS /883 (CLASS H)

	QML				
	CLASS H /883				
COMPONENT-LEVEL TEST PERFORMED	M/S <sup>2</sup>	Р <sup>3</sup>			
Element Electrical					
Visual					
Internal Visual					
Final Electrical					
Wire Bond Evaluation					

Notes

1. Element evaluation does not apply to standard and /ES product.

2. M/S = Active components (microcircuit and semiconductor die).

 P = Passive components, Class H element evaluation. Not applicable to standard and /ES element evaluation.

TABLE 12: ELEMENT EVALUATION

### 28 VOLT INPUT – 1.5 WATT

# ENVIRONMENTAL SCREENING HIGH RELIABILITY STANDARD, /ES AND /883 (CLASS H)

	NON-Q	ML <sup>1</sup>	CLASS H QML <sup>2</sup>	
TEST PERFORMED	STANDARD	/ES	/883	
Pre-cap Inspection, Method 2017, 2032				
Temperature Cycle (10 times)				
Method 1010, Cond. C, -65°C to +150°C, ambient				
Method 1010, Cond. B, -55°C to +125°C, ambient				
Constant Acceleration				
Method 2001, 3000 g			-	
Method 2001, 500 g				
PIND, Test Method 2020, Cond. A			<b>∎</b> 3	
Burn-in Method 1015, +125°C case, typical <sup>4</sup>				
96 hours		•		
160 hours				
Final Electrical Test, MIL-PRF-38534, Group A,				
Subgroups 1 through 6, -55°C, +25°C, +125°C case			-	
Subgroups 1 and 4, +25°C case				
Hermeticity Test				
Gross Leak, Cond. C1, fluorocarbon		•		
Fine Leak, Cond. A <sub>2</sub> , helium				
Gross Leak, Dip				
Final visual inspection, Method 2009				

Test methods are referenced to MIL-STD-883 as determined by MIL-PRF-38534.

Notes

1. Non-QML products may not meet all of the requirements of MIL-PRF-38534.

2. All processes are QML qualified and performed by certified operators.

3. Not required by DLA but performed to assure product quality.

4. Burn-in temperature designed to bring the case temperature to +125°C minimum. Burn-in is a powered test.

TABLE 13: ENVIRONMENTAL SCREENING

